

Creation of economical and robust large area MCPs by ALD method for photodetectors

Session Detector: R&D and Performance

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- HEP LAPPD Collaboration
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- Funding agencies



U.S. DEPARTMENT OF
ENERGY



Outline

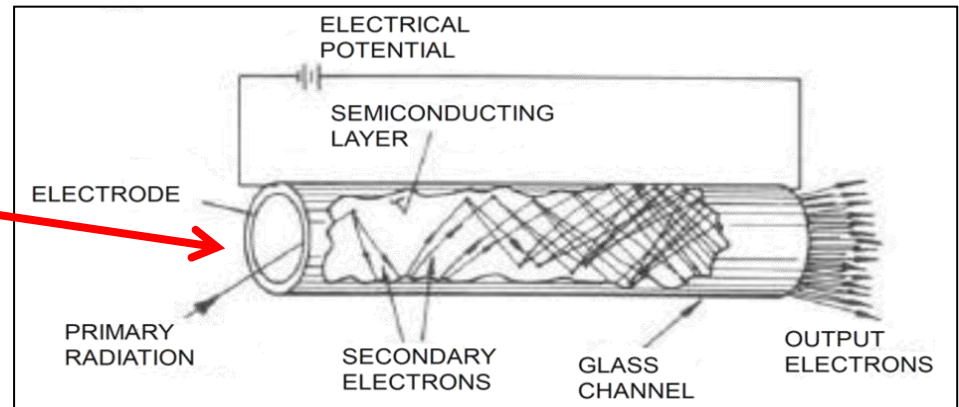
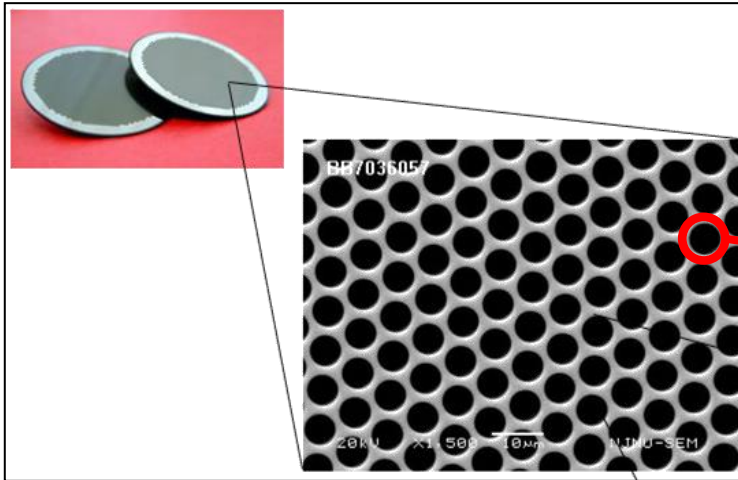
- **Overview: ALD-MCPs technology**
- **ALD Processes for MCPs creation**
- **ALD-MCPs Testing**
- **Summary**



Applications of MCPs

- Photodetectors, time-of-flight (ToF) mass spectrometry, molecular and atomic collision studies, electron microscopy, field emission displays, and night vision goggles and binoculars, medical imaging (PET scanners), homeland security (scanners for shipping containers and trucks), X-ray and Neutrons detection
- **Large HEP experiments**
 - LBNE/DUNE/ μ BooNE @Fermi Lab,
 - Super-K RICH and BELLE II @Japan,
 - LHC, ATLAS and CMS @CERN,
 - Mark-I @SLAC
 - PANDA @FAIR Germany,
 - JUNO @China,
 - CLAS12 @Jefferson Lab,
 - NASA Space Mission

Microchannel Plates (MCPs)



Conventional Fabrication Method:

- Draw lead glass fiber bundle
- Slice and polish
- Chemical etch
- Hydrogen firing

Issues:

- Expensive and need to import
- Resistance and secondary emission properties are linked
- Very long conditioning timing
- Contains lead
- Available in small form factor

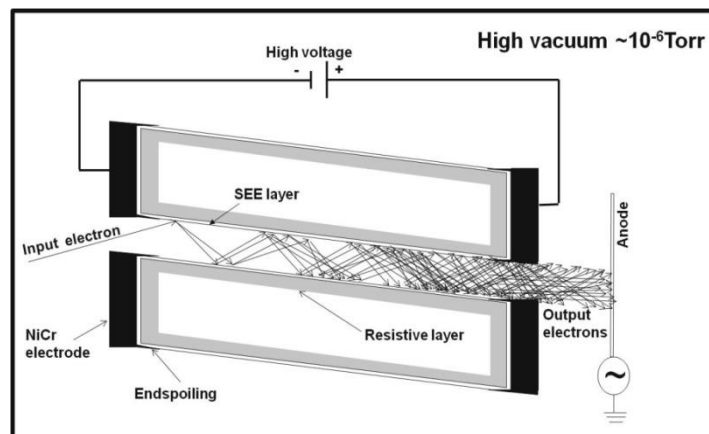
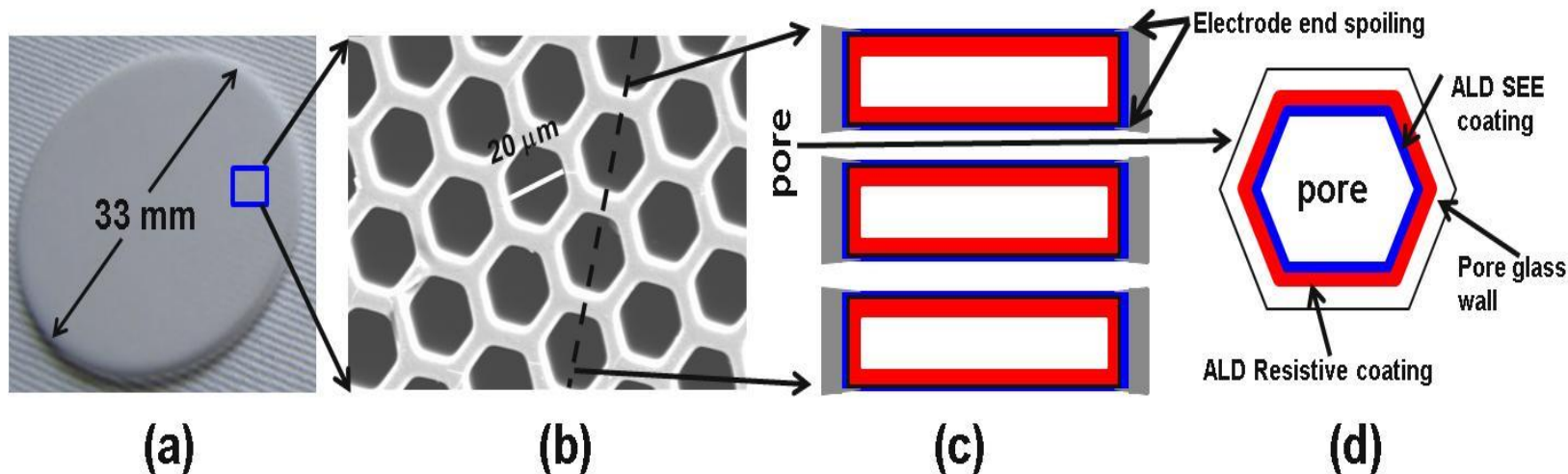
Objective:

Development of large area microchannel plate (MCP)-based photodetectors (DOE HEP LAPPD™ sponsored project)

Key Tasks:

Creation of sturdy resistive (R) and secondary electron emission (SEE) coatings for porous substrates (e.g. Micro Capillary Array structures) to form desire MCPs

New Strategy - ALD Functionalization of Porous Glass

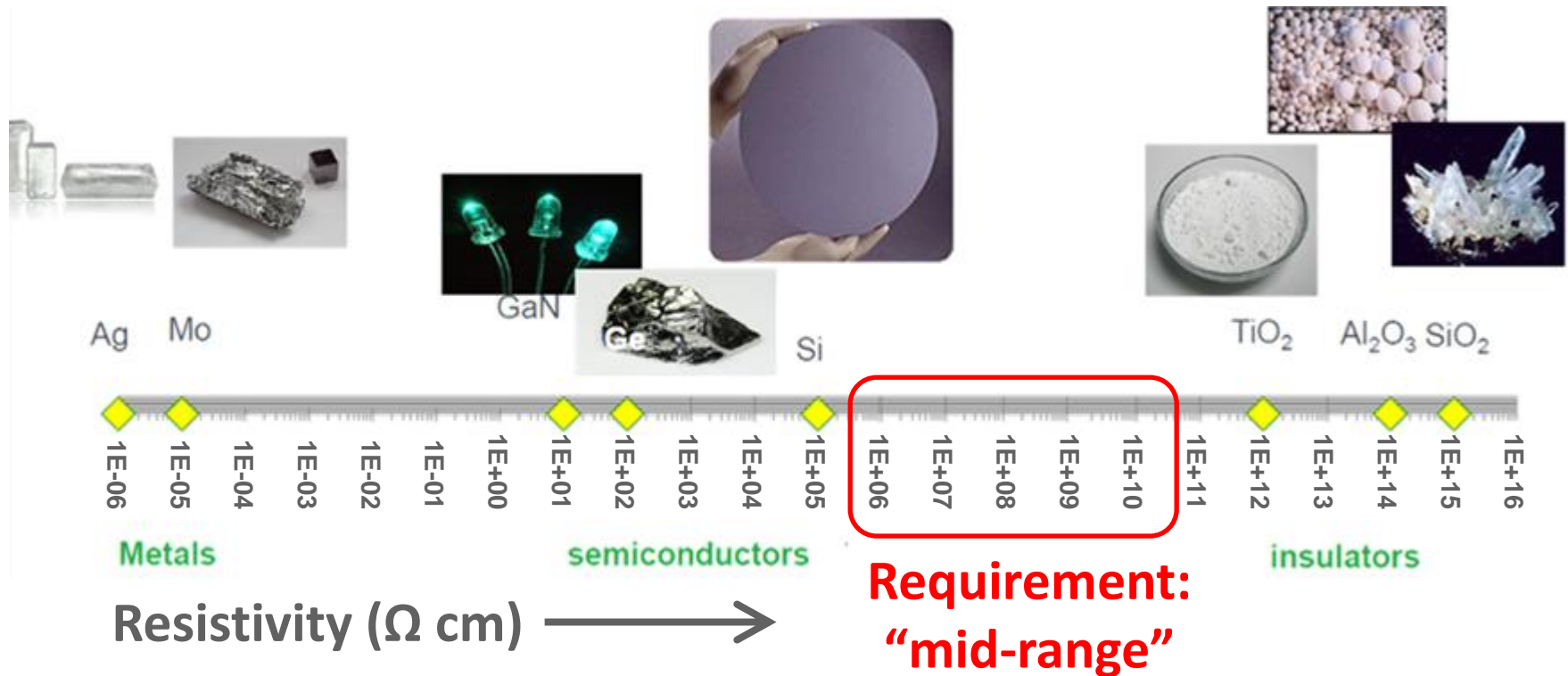


- 1) Resistive coating (ALD)
- 2) Emissive coating (ALD)
- 3) Contact electrode (PVD)

A. Mane et al., SPIE (2011)

D. Beaulieu, et al., Nucl. Instr. Meth. Phys. A, 633, S59, (2011)

Resistivity Requirement for MCPs : “Mid-Range”



- Practically no naturally occurring materials with “mid-range” resistivity of 10^6 - 10^{10} $\Omega \text{ cm}$
- **Must be synthesized or engineered**

ALD of M-Al₂O₃ Composites (Where M = W or Mo)

- Precursors used = Al(CH₃)₃, H₂O, WF₆, MoF₆, Si₂H₆
- Precursors properties: High vapor pressure, availability, and low cost
- ALD growth:
 - Growth of pure layers : W, Mo and Al₂O₃
 - Growth composite layers : W-Al₂O₃, and Mo-Al₂O₃
- Low temperature deposition processes (100-400°C)
- Process scale up

Mane et.al., (US20130280546)

Mane et.al., (US20140220244)

Mane et.al., SPIE 2013

Mane et.al., CVD (2013) 186

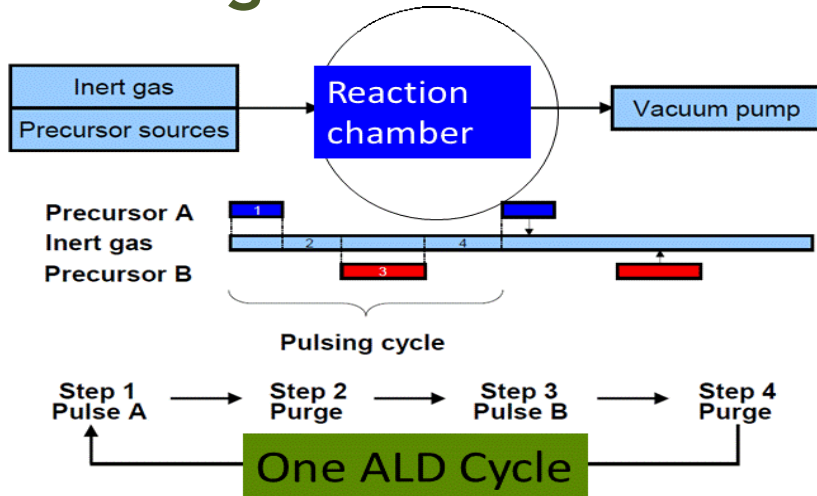
Elam et.al., ECS 2013

W. Tong et.al., APL 102 (2013) 252901

Mane et.al., (Application # 14/693,719)

Mane et.al., ECS 2014

ALD thin film growth methodology

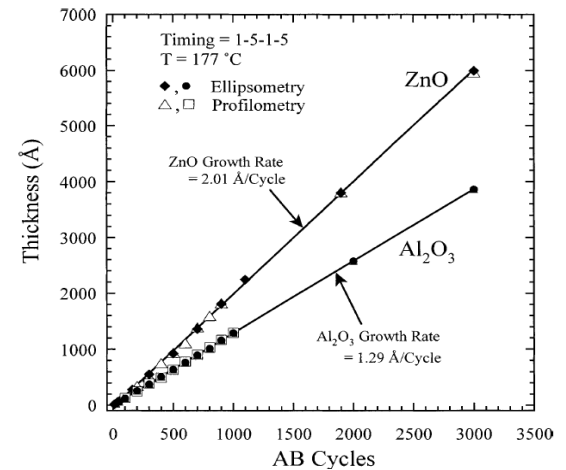
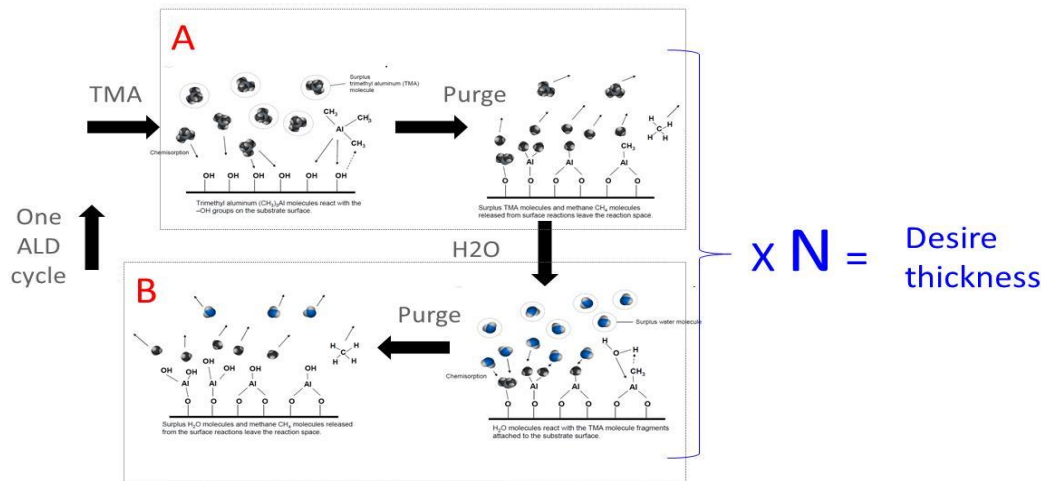


e.g.

- 1) ALD of Al_2O_3 by TMA and H_2O
- 2) ALD of ZnO by DEZ and H_2O

Elam, Chem. Mater., Vol. 15, No. 4, 2003

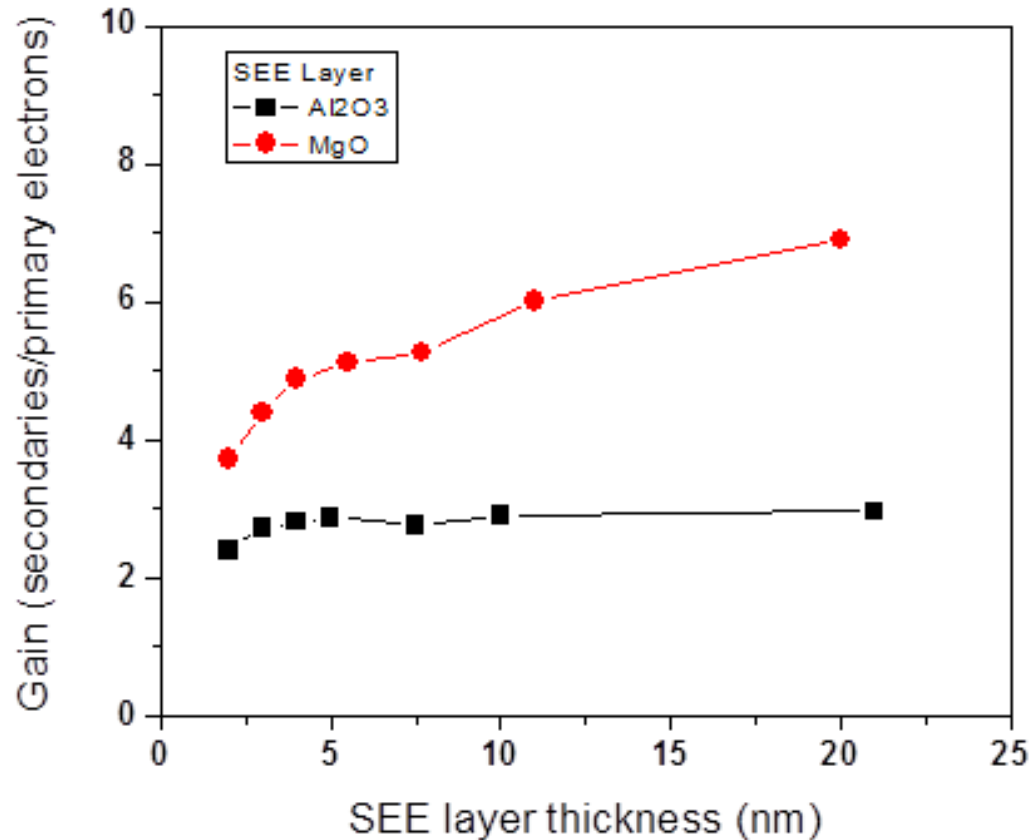
Example (SEE layer) : ALD Al_2O_3 using TMA- H_2O



• Precursor introduce separately in time and space



ALD Grown Secondary Electron Emission Layers

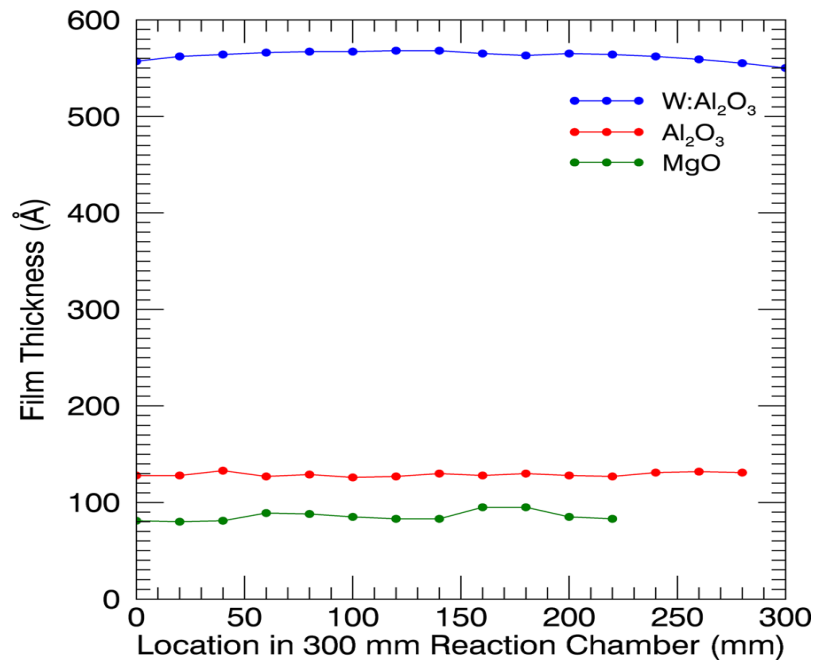


- Thickness and high gain

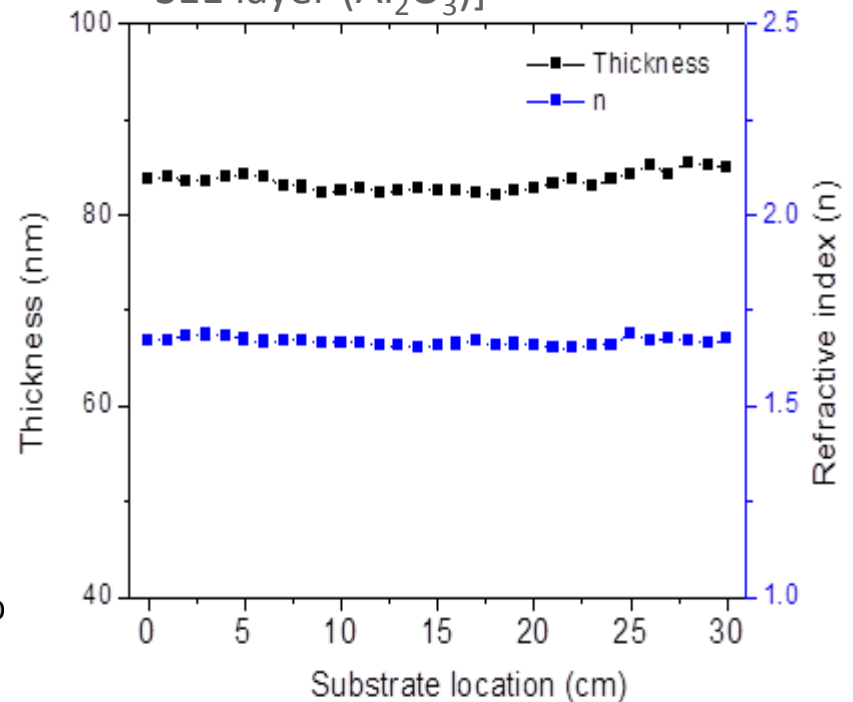
Jokela et al. Aip Conf Proc, (2011) 1336, 208

Uniformity of the functional ALD coatings on MCPs

Individual ALD layers



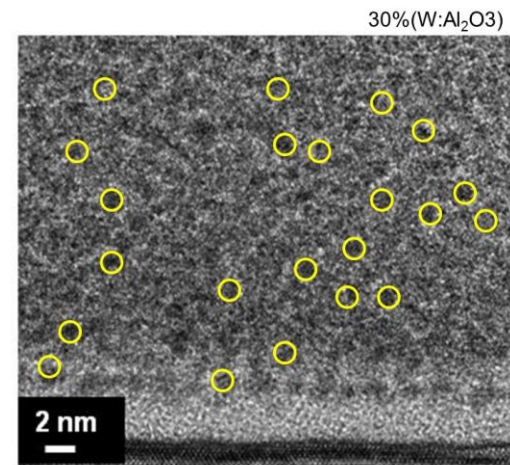
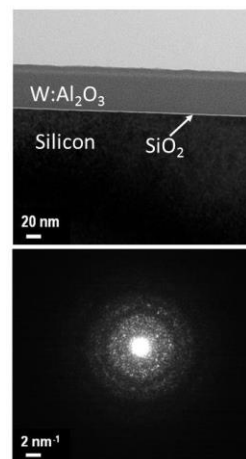
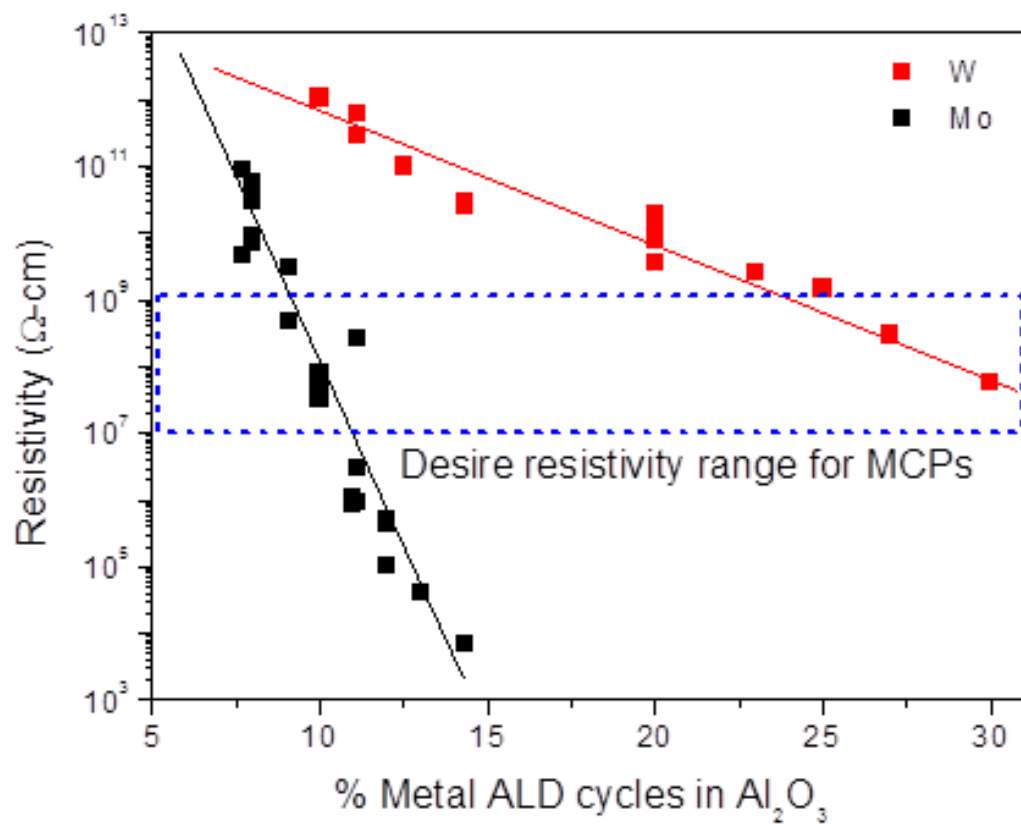
Stack of [Resistive layer (W:Al₂O₃) + SEE layer (Al₂O₃)]



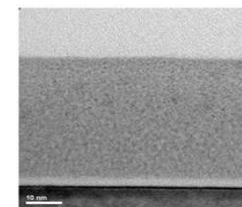
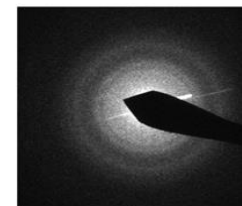
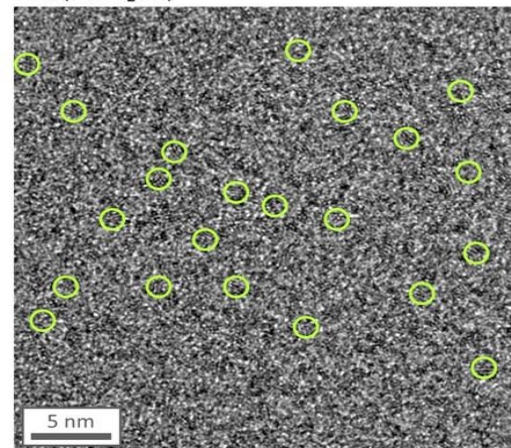
O'Mahony et. al. *JVST A* **34**, 01A128 (2016)



ALD of ($M:Al_2O_3$; where $M=Mo$ or W) Nanocomposites



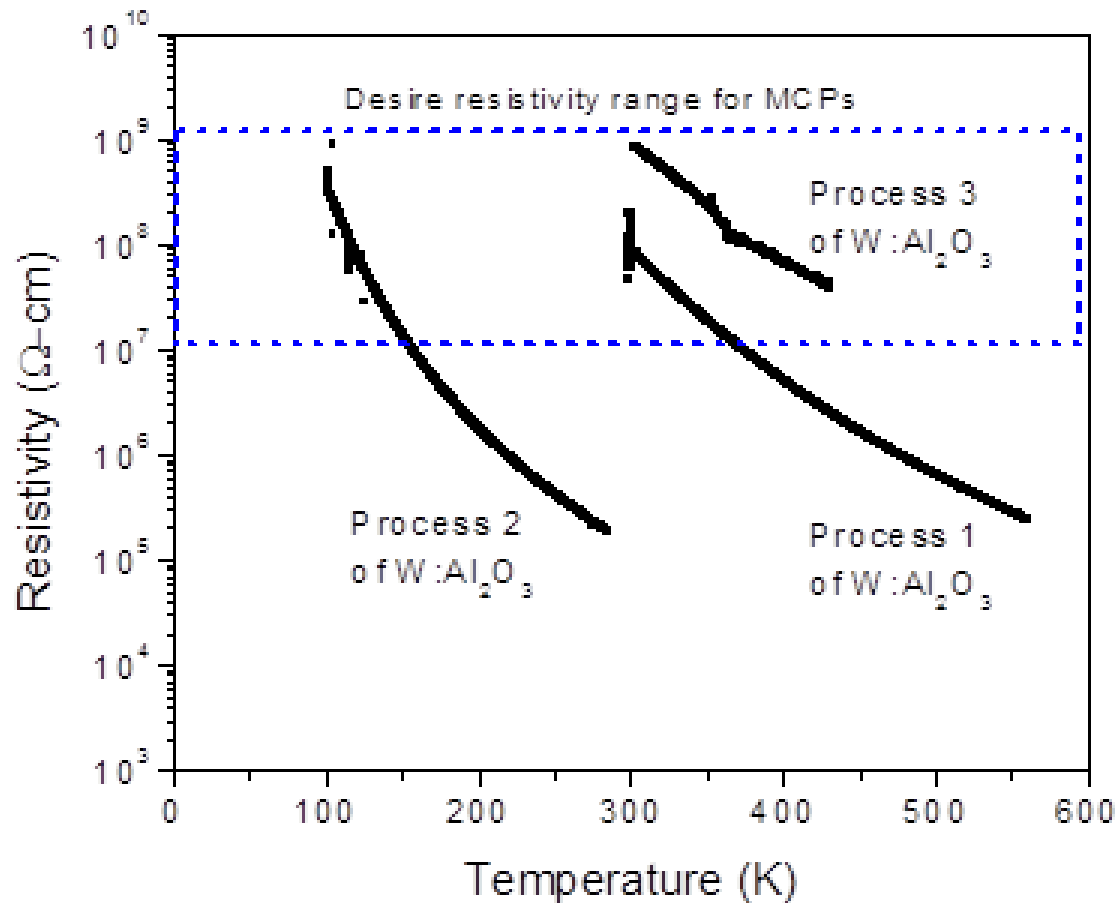
10% ($Mo:Al_2O_3$)



Mane et al., CVD (2013) 186

Mane et al., ECS 2014

Adjusting Resistivity of MCPs for various operations



- Process -1 for Around Room Temperature MCP operation
- Process -2 for Low Temperature MCP operation (Liquid Ar)
- Process -3 for High Temperature MCP operation

Small ALD MCP Fabrication and Performance

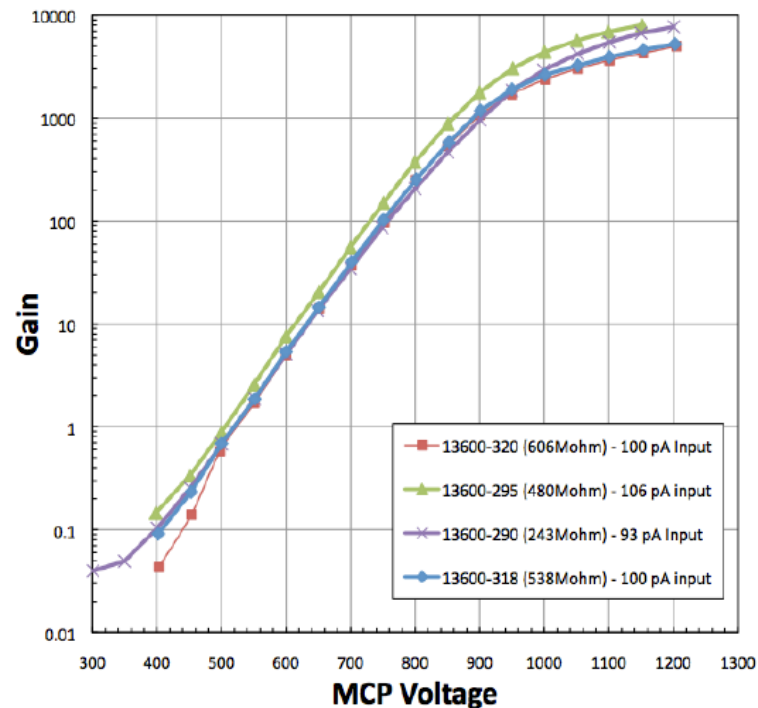
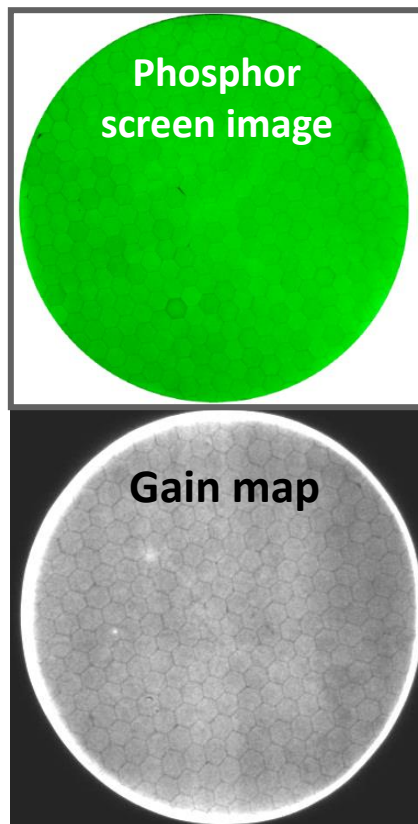
33 mm capillary glass array (Incom)



With ALD Mo-Al₂O₃ resistive coating and ALD MgO emissive layer



With PVD NiCr electrode

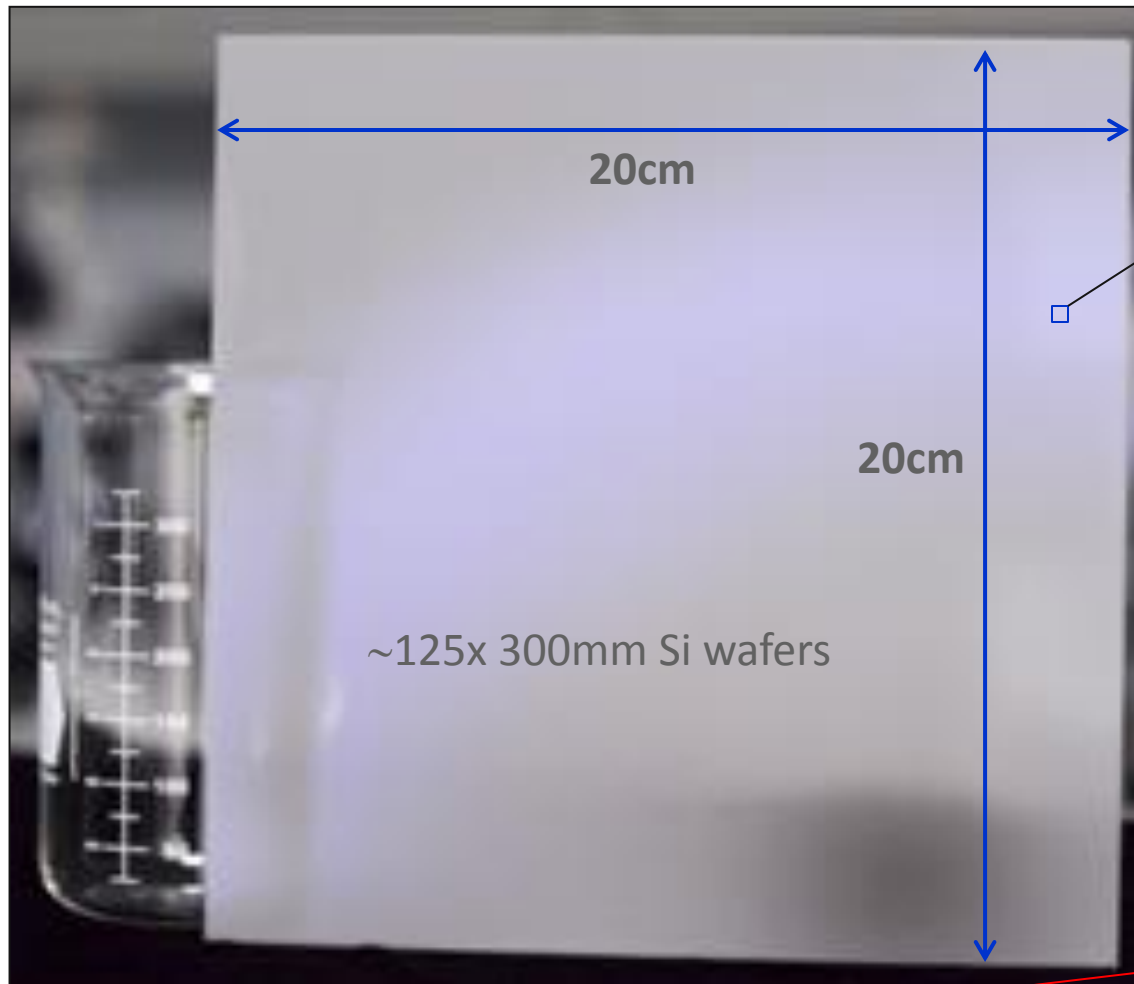


Easy to functionalized by ALD

- Gain is spatially uniform
- Gain of $\sim 10^4$, (comparable to commercial MCPs)
- Very low background

A. U. Mane et. al., Chem. Vap. Deposition, **19**, 186–193, (2013)
A. U. Mane et. al., Physics Procedia, **37**, 722-732 (2012)
O. H. W. Siegmund et. al., Physics Procedia, **37**, 803-810 (2012)

Capillary Glass Array Substrates for MCPs

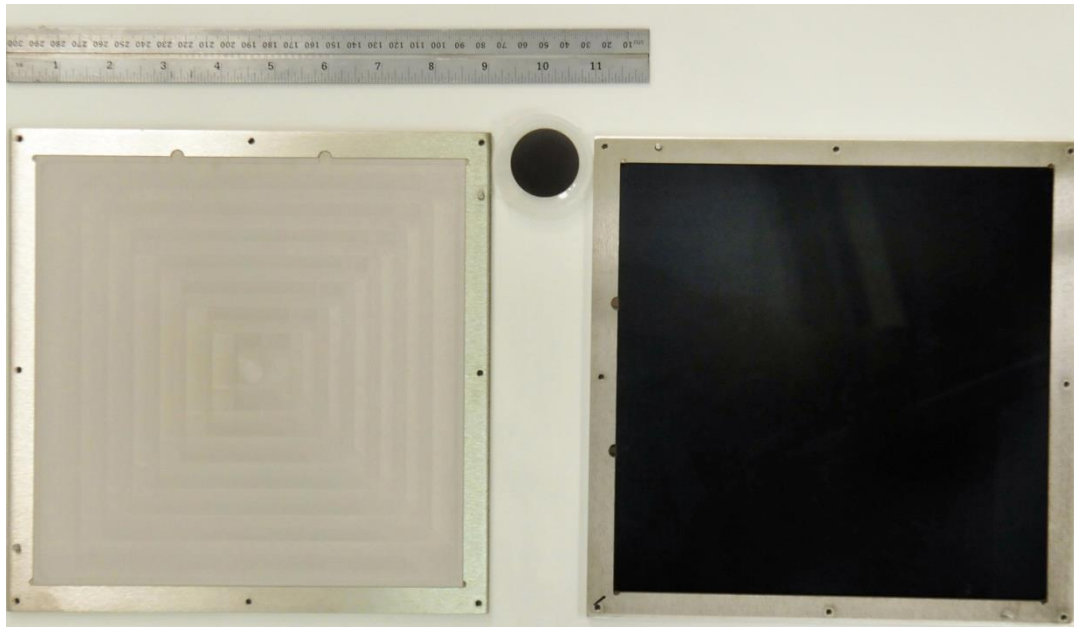


- Surface area = 8.7 m²
- Aspect Ratio = 60
- **No. of Pores = ~80Millions**
- Porosity = 65%
- Bias Angle = 8°
- Pore size = 20μm
- Thickness of plate=1.2mm
- Sensitive Surface to OH
- Complex Geometry

- **Very challenging substrate to coat for any thin film deposition method**

Mane et.al., (US Patent # US20140220244)

Large Area ALD MCPs



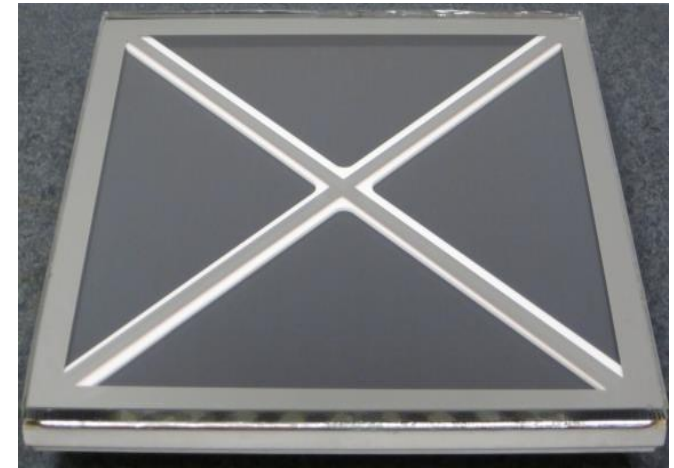
Bare MCA

ALD MCP

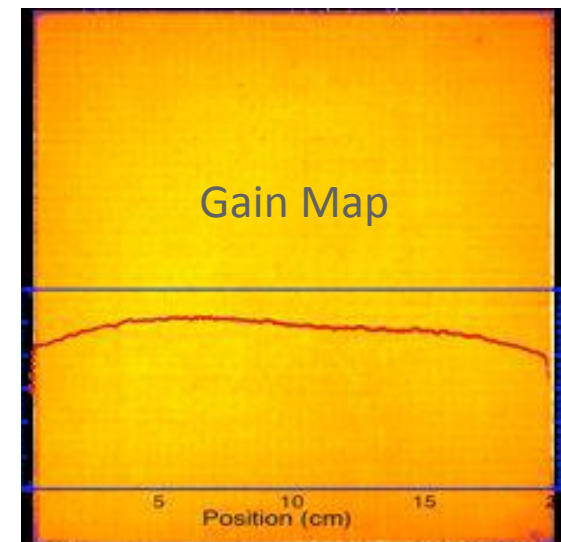
- High Gain ($>10^5$)/mcp
- Very Low Background
- 10x *psec* time resolution
- 100 μ m spatial resolution
- Excellent Stability
- Short (2-3days) scrubbing time

>200 publications using ALD MCPs, from LAPPD collaboration (<http://psec.uchicago.edu/>)

8"x8" MCP-photodetector tile



ALD MCPs in Photodetector



Working 20cm x20cm MCP in large area photodetector

Photographs of various types of ALD MCPs



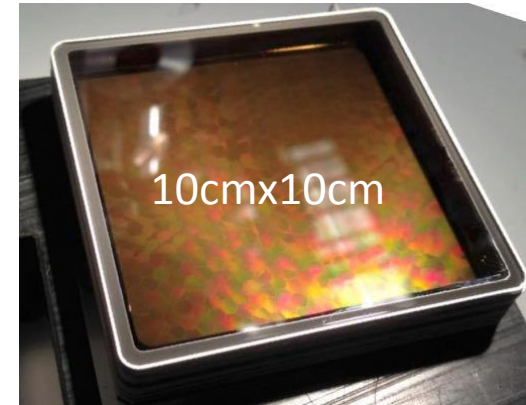
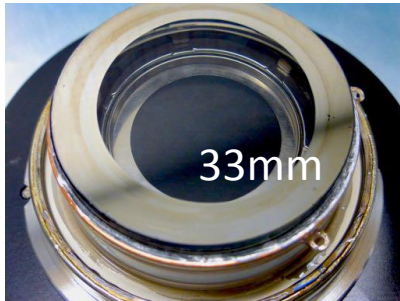
Curtesy : Incom Inc. UCB and LAPPD

Photographs of various types of ALD MCPs



Curtesy : Incom Inc. UCB and LAPPD

Photodetectors made with ALD MCPs



Great cost saving!!!

2 x 3 Super-Module Mockup

Summary

- Demonstrated ALD nanostructure materials functionalization path to create economical large area high performance MCPs
- Various type photodetectors are made with ALD-MCP and displays long life sturdy performance
- Commercialization of ALD-MCPs and LAPPD™ technology is in progress (with Incom Inc, MA) and will have impact on near/long terms MCP-based detectors applications in various areas such as HEP, Nuclear, Biology, Materials, Medical, Transportation, Space programs, etc.

Thank you !!!